CELNEC's C TO Ku BAND
SUPER LOW NOISE AND
HIGH-GAIN AMPLIFIER N-CHANNEL HJ-FETNE3503M04

FEATURES

- SUPER LOW NOISE FIGURE AND HIGH ASSOCIATED GAIN: NF = 0.55 dB TYP., $G_a = 11.5$ dB TYP. @ V_{DS} = 2 V, I_D = 10 mA, f = 12 GHz
- FLAT-LEAD 4-PIN THIN-TYPE SUPER MINIMOLD (M04) PACKAGE:

• GATE WIDTH:

 $W_g = 160 \ \mu m$



APPLICATIONS

- DBS LNB gain-stage, Mix-stage
- Low noise amplifier for microwave communication system

PART NUMBER	QUANTITY	PACKAGE	MARKING	SUPPLYING FORM
NE3503M04-A	50 pcs (Non reel)	4-Pin thin-type	V75	8 mm wide embossed taping
NE3503M04-T2-A	3 kpcs/reel	super minimold (Pb-Free)		 Pin 1 (Source), Pin 2 (Drain) face the perforation side of the tape

Remark To order evaluation samples, contact your nearby sales office. Part number for sample order: NE3503M04-A

ABSOLUTE MAXIMUM RATINGS (TA = +25°C)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain to Source Voltage	Vds	4.0	V
Gate to Source Voltage	Vgs	-3.0	V
Drain Current	lo	loss	mA
Gate Current	la	80	μA
Total Power Dissipation	Ptot	125	mW
Channel Temperature	Tch	+125	°C
Storage Temperature	Tstg	-65 to +125	°C

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

ORDERING INFORMATION

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Drain to Source Voltage	VDS	-	2	3	V
Drain Current	lo	-	10	15	mA
Input Power	Pin	-	-	0	dBm

RECOMMENDED OPERATING CONDITIONS (TA = +25°C)

ELECTRICAL CHARACTERISTICS (TA = +25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Gate to Source Leak Current	lgso	Vgs = -3.0 V	-	0.5	10	μA
Saturated Drain Current	loss	$V_{DS} = 2 V, V_{GS} = 0 V$	15	40	70	mA
Gate to Source Cutoff Voltage	VGS (off)	$V_{DS} = 2 V$, $I_D = 100 \mu A$	-0.2	-0.7	-2.0	V
Transconductance	Яm	$V_{DS} = 2 V, I_{D} = 10 mA$	40	55	-	mS
Noise Figure	NF	$V_{DS} = 2 V$, $I_{D} = 10 mA$, $f = 12 GHz$	-	0.55	0.75	dB
Associated Gain	Ga		10.5	11.5	-	dB

TYPICAL CHARACTERISTICS (TA = +25°C, unless otherwise specified)





PACKAGE DIMENSIONS FLAT-LEAD 4-PIN THIN-TYPE SUPER MINIMOLD (M04) (UNIT:mm)



PIN CONNECTIONS

- 1. Source
- 2. Drain
- 3. Source
- 4. Gate

MOUNTING PAD DIMENSIONS

FLAT-LEAD 4-PIN THIN-TYPE SUPER MINIMOLD (M04) PACKAGE (UNIT:mm)

Reference 1



Reference 2



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature)	: 260°C or below	IR260
	Time at peak temperature	: 10 seconds or less	
	Time at temperature of 220°C or higher	: 60 seconds or less	
	Preheating time at 120 to 180°C	: 120±30 seconds	
	Maximum number of reflow processes	: 3 times	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	
Partial Heating	Peak temperature (pin temperature)	: 350°C or below	HS350
	Soldering time (per side of device)	: 3 seconds or less	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	

Caution Do not use different soldering methods together (except for partial heating).

Life Support Applications

These NEC products are not intended for use in life support devices, appliances, or systems where the malfunction of these products can reasonably be expected to result in personal injury. The customers of CEL using or selling these products for use in such applications do so at their own risk and agree to fully indemnify CEL for all damages resulting from such improper use or sale.

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Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices	
Lead (Pb)	< 1000 PPM	-A-AZNot Detected(*)	
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
РВВ	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

See CEL Terms and Conditions for additional clarification of warranties and liability.

Important Information and Disclaimer: Information provided by CEL on its website or in other communications concerting the substance content of its products represents knowledge and belief as of the date that it is provided. CEL bases its knowledge and belief on information provided by third parties and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. CEL has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. CEL and CEL suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall CEL's liability arising out of such information exceed the total purchase price of the CEL part(s) at issue sold by CEL to customer on an annual basis.